



# Material Composition Declaration

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This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.

Adobe Reader version 7.0.5 is required to complete this declaration.

1752-2 1.1	IPC Web Site for Information on IPC-1752 Standard <a href="http://www.ipc.org/IPC-175x">http://www.ipc.org/IPC-175x</a>	Form Type * Distribute	Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Materials and Mfg Informat
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## Supplier Information

Company Name *	Company Unique ID	Unique ID Authority	Response Date *	Response Document ID				
SEMTECH CORPORATION	00-847-9941	DUNS	2018-03-20					
Contact Name *	Title - Contact	Phone - Contact *	Email - Contact *	Duplicate Contact -> Authorized Representative				
Karen Pimental	QA Customer Support Specilia	805-498-2111	kpimental@semtech.com					
Authorized Representative *	Title - Representative	Phone - Representative *	Email - Representative *	Supplier Comments or URL for Additional Information				
Karen Pimental	QA Customer Support Specilia	805-498-2111	kpimental@semtech.com					
Requester Item Number	Mfr Item Number	Mfr Item Name	Effective Date	Version	Manufacturing Site	Weight *	UOM	Unit Type
	RClamp7534P.TNT	High-Power µClamp@ 1-Line Su			China	2.207	mg	Each
Alternate Recommendation				Alternate Item Comments				

## Manufacturing Process Information

Terminal Plating / Grid Array Material	Terminal Base Alloy	J-STD-020 MSL Rating	Peak Process Body Temperature	Max Time at Peak Temperature	Number of Reflow Cycles
Nickel/Palladium/Gold (Ni/Pd/Au)	CU Alloy	1	260 C	30 seconds	3

Comments  
RClamp7534P.TNT is REACH-compliant product, per EU Regulation EC1907/2006 to include recent addition of SVHC candidate list of substances in January 2018.

Save the fields in this form to a file

Export Data

Import fields from a file into this form

Import Data

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Reset Form

Lock the fields on this form to prevent changes

Lock Supplier Fields

## RoHS Material Composition Declaration

Declaration Type \*

Detailed

**RoHS Directive 2002/95/EC** **RoHS Definition:** Quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury, Hexavalent Chromium, Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE) and quantity limit of 0.01% by mass (100 PPM) of homogeneous material for Cadmium

Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2002/95/EC and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalent chromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a RoHS restricted substance?) in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance in excess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information it provides in this form using appropriate methods to ensure its accuracy and that such information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier has not independently verified information provided by others, Supplier agrees that, at a minimum, its suppliers have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusive source of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.

RoHS Declaration \*

1 - Item(s) does not contain RoHS restricted substances per the definition above

Supplier Acceptance \*

Accepted

**Exemptions:** If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.

## Declaration Signature

**Instructions:** Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.

Supplier Digital Signature

## Homogeneous Material Composition Declaration for Electronic Products

**SubItem Instructions:** The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

**Substance Instructions:** [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

**Line Functions:** +I Inserts a New Item /SubItem +M Inserts a new Material +C Inserts a new Substance Category +S Inserts a new Substance - Deletes the element line

Item/SubItem Name		Homogeneous Material		Weight	Unit of Measure	Level		Substance Category	Substance		CAS	Exempt	Weight	Unit of Measure	Tolerance		PPM											
+I	-I	+M	-M			+C	-C		+S	-S					-	+												
+I	-I			Die		+M	-M	Doped silicon	0.052	mg	+C	-C	Supplier		+S	-S	Si	7440-21-3		0.0506	mg				22,935			
															+S	-S	Al	7429-90-5		0.0013	mg				574			
+I	-I			Leadframe		+M	-M	SGP2010N5 Sub	0.832835	mg	+C	-C	Supplier	CCL-HL832NX Core M	+S	-S	Bismaleimide Triazine r	105391-33-1		0.1165	mg				52,834			
															+S	-S	Inorganic Filler	21645-51-2		0.0583	mg				26,417			
															+S	-S	Continuous Filament Fi	65997-17-3		0.1165	mg				52,834			
															+S	-S	Copper	7440-50-8		0.2914	mg				132,08			
						+C	-C	Supplier						PSR-4000 Solder Mas	+S	-S	Acrylic Esters	26376-86-32		0.0676	mg				30,660			
															+S	-S	Organic black dye	Proprietary		0.0011	mg				513			
															+S	-S	Barium Sulfate	7727-43-7		0.0683	mg				30,956			
															+S	-S	Talc	14807-96-6		0.0057	mg				2,590			
															+S	-S	Silica crystalline	7631-86-9		0.0059	mg				2,657			
															+S	-S	Activator	Proprietary		0.0118	mg				5,367			
															+S	-S	Amine compound	Proprietary		0.0007	mg				320			
															+S	-S	Defoamer	Proprietary		0.0051	mg				2,310			
															+S	-S	Dipropyl glycol dinitrate	112-15-2		0.0227	mg				10,308			
															+S	-S	Heavy aromatic solvent	64742-94-5		0.0233	mg				10,579			
															+S	-S	Naphthalene	91-20-3		0.0014	mg				614			
						+M	-M	NiPdAu plating	0.062	mg	+C	-C	B		+S	-S	Nickel	7440-02-0		0.0051	mg				2,334			
															+C	-C	Supplier	middle plating	+S	-S	Pd	7440-05-3		0.0506	mg			22,954
															+C	-C	Supplier	outer plating	+S	-S	Au	7440-57-5		0.006	mg			2,723
+I	-I			Bonding wire		+M	-M	CuPd	0.011	mg	+C	-C	Supplier		+S	-S	Cu	7440-50-8		0.0106	mg				4,816			
															+S	-S	Pd	7440-05-3		0.0003	mg				123			
+I	-I			Molding compound		+M	-M	EME-G760L	1.259	mg	+C	-C	Supplier		+S	-S	Silica (Amorphous) A	60676-8 6-0		0.9757	mg				442,30			

+S	-S	Silica (Amorphous) B	7631-86-9		0.1007	mg			45,657
+S	-S	Epoxy resin	Proprietary		0.1007	mg			45,657
+S	-S	Phenol resin	9003-35-4		0.0378	mg			17,121
+S	-S	Metal Hydroxide	Proprietary		0.0378	mg			17,121
+S	-S	Carbon Black	1333-86-4		0.0063	mg			2,854

+I	-I	Die attached epoxy	+M	-M	8006NS - Henkel	0.026	mg	+C	-C	Supplier		+S	-S	Aluminum Oxide	1344-28-1		0.0088	mg			4,006
												+S	-S	Diethylene glycol mono	112-15-2		0.0088	mg			4,006
												+S	-S	Epoxy resins	Proprietary		0.0073	mg			3,299
												+S	-S	Amine	Proprietary		0.001	mg			471